

IESTI01 – TinyML

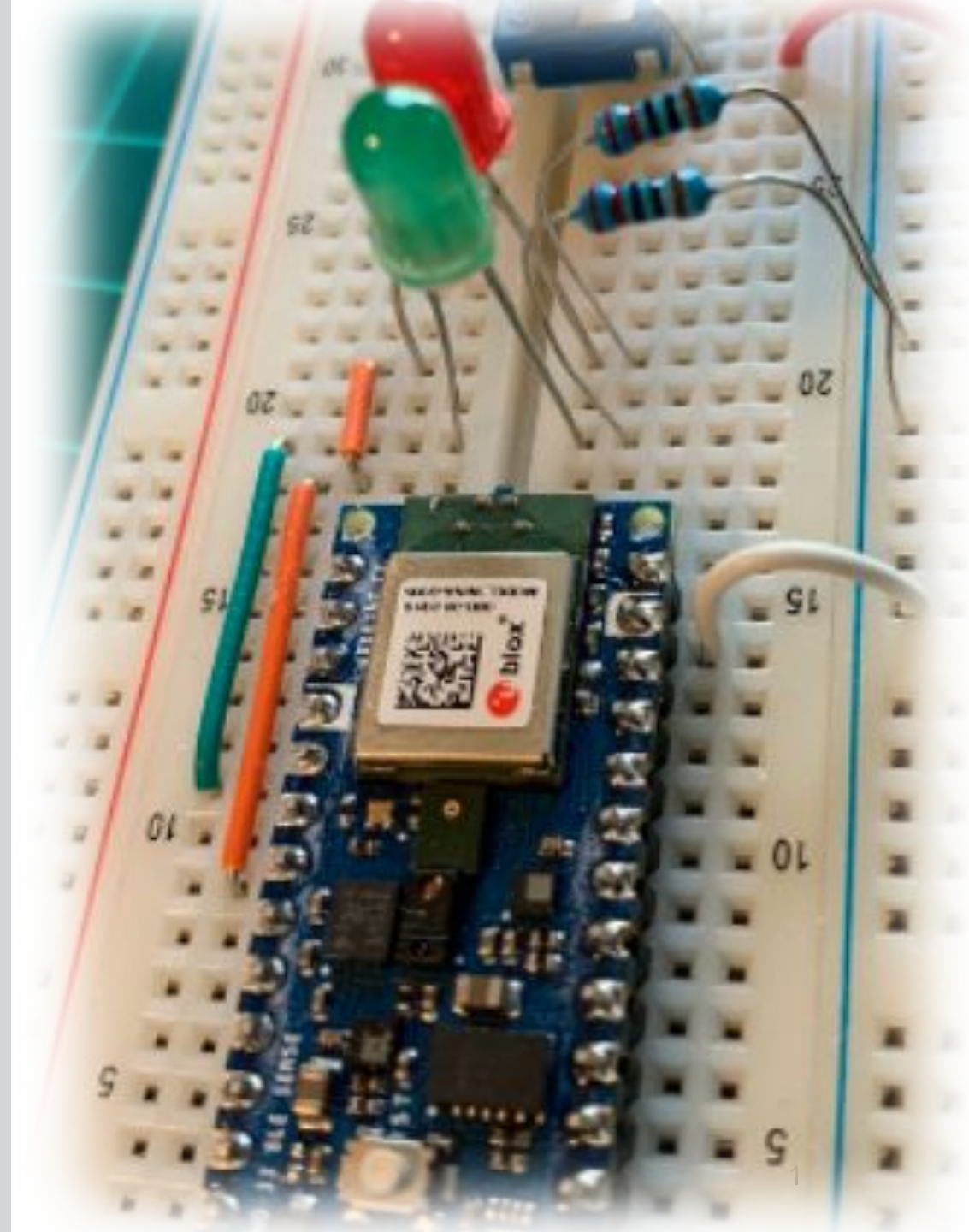
Embedded Machine Learning

28. Responsible AI & Curse Wrap-up



Prof. Marcelo Rovai

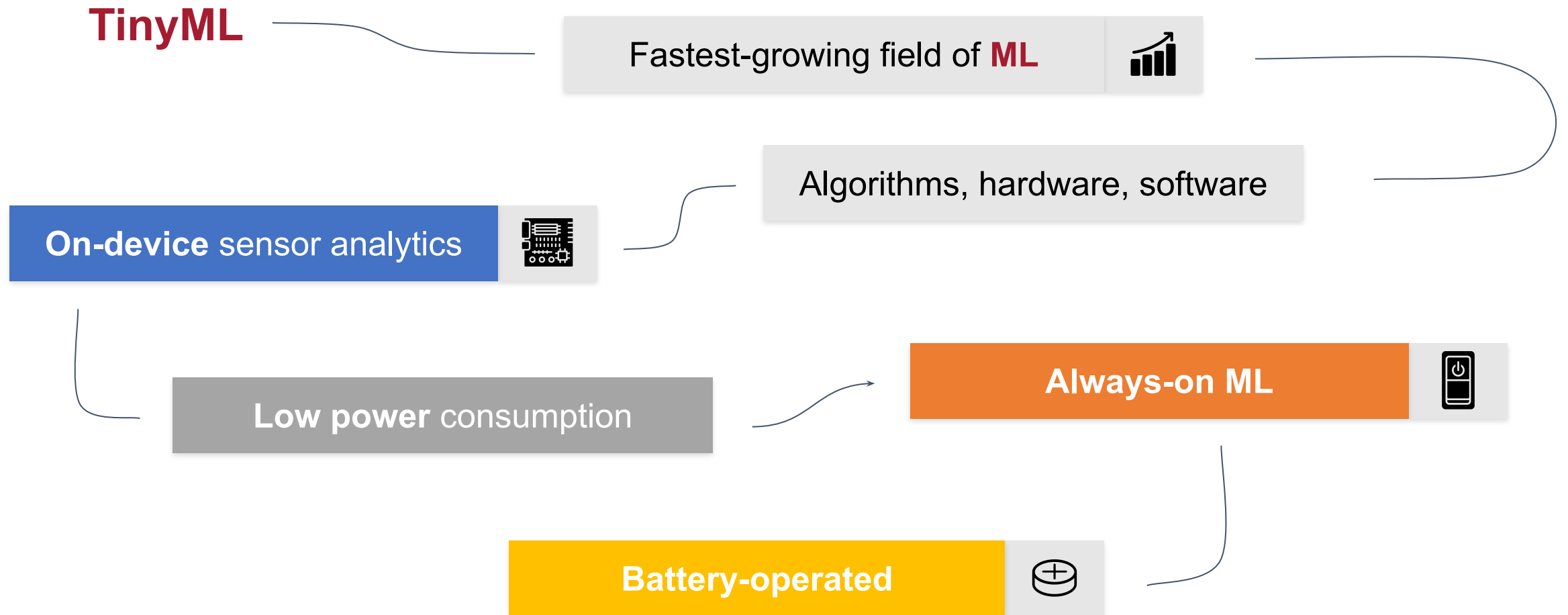
UNIFEI



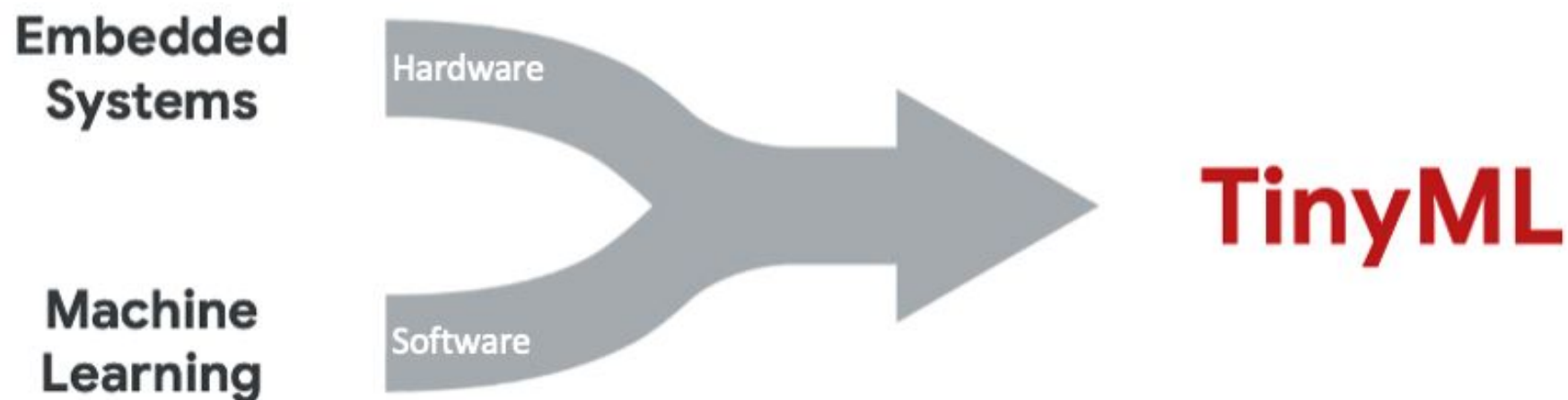
Embedded ML

Curse Wrap-up

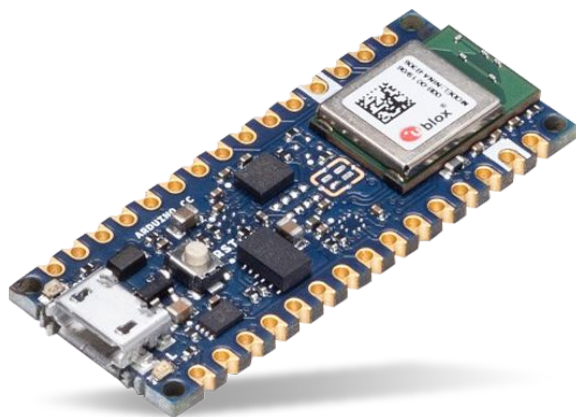
What is Tiny Machine Learning (**TinyML**)?



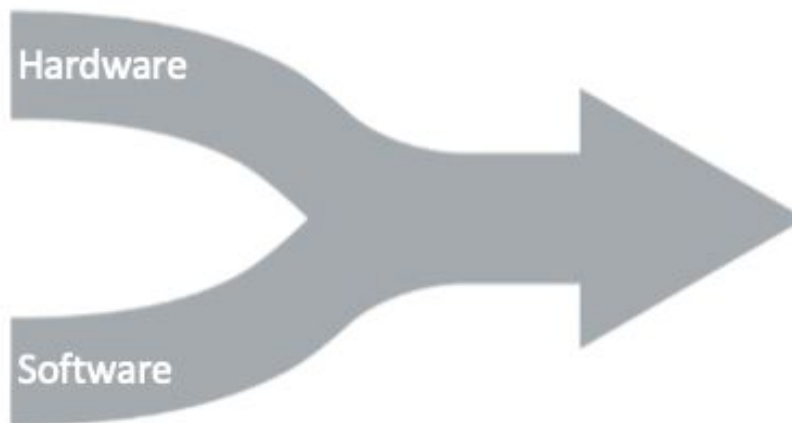
What Makes **TinyML**?



What Makes **TinyML**?



TensorFlow Lite

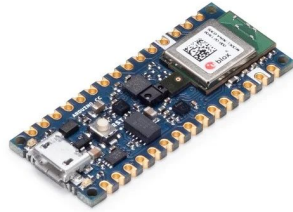


TinyML

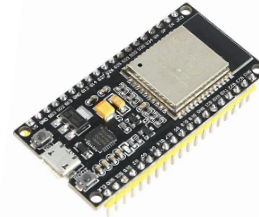
Hardware (Dev. Boards)



Raspberry Pico (W)



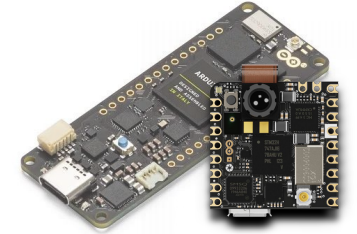
Arduino Nano Sense



Espressif ESP 32



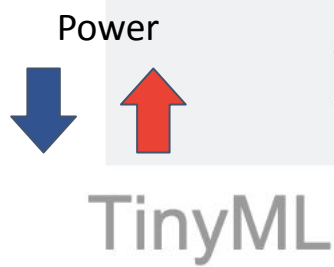
Seeed XIAO ESP32S3 Sense



Arduino Pro

	Raspberry Pico (W)	Arduino Nano Sense	Espressif ESP 32	Seeed XIAO ESP32S3 Sense	Arduino Pro
32Bits CPU	Dual-core Arm Cortex-M0+	Arm Cortex-M4F	Xtensa LX6 Dual Core	Xtensa LX7 Dual Core	Dual Core Arm Cortex M7/M4
CLOCK	133MHz	64MHz	240MHz	240MHz	480/240MHz
RAM	264KB	256KB	520KB (part available)	8MB (PSRAM)	1MB
ROM	2MB	1MB	2MB	8MB	2MB
Radio	(Yes for W)	BLE	BLE / WiFi	BLE / WiFi	BLE / WiFi
Sensors	No	Yes	No	Yes	Yes (Nicla)
Bat. Power Manag.	No	No	No	Yes	Yes
Price	\$	\$\$\$	\$	\$\$	\$\$\$\$\$

Hardware



EdgeML



Anomaly Detection
Sensor Classification
20 KB

KeyWord Spotting
Audio Classification
50 KB

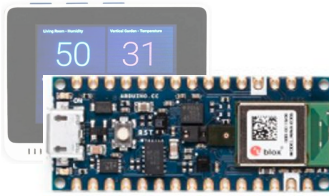
Image
Classification
250 KB+

Object Detection
Complex Voice
Processing
1 MB+

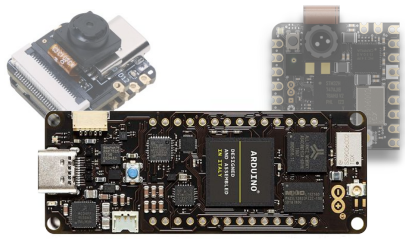
Video
Classification
2 MB+



Rpi-Pico
(Cortex-M0+)



Arduino Nano
(Cortex-M4)



Arduino Pro
(Cortex-M7)



RaspberryPi
(Cortex-A)

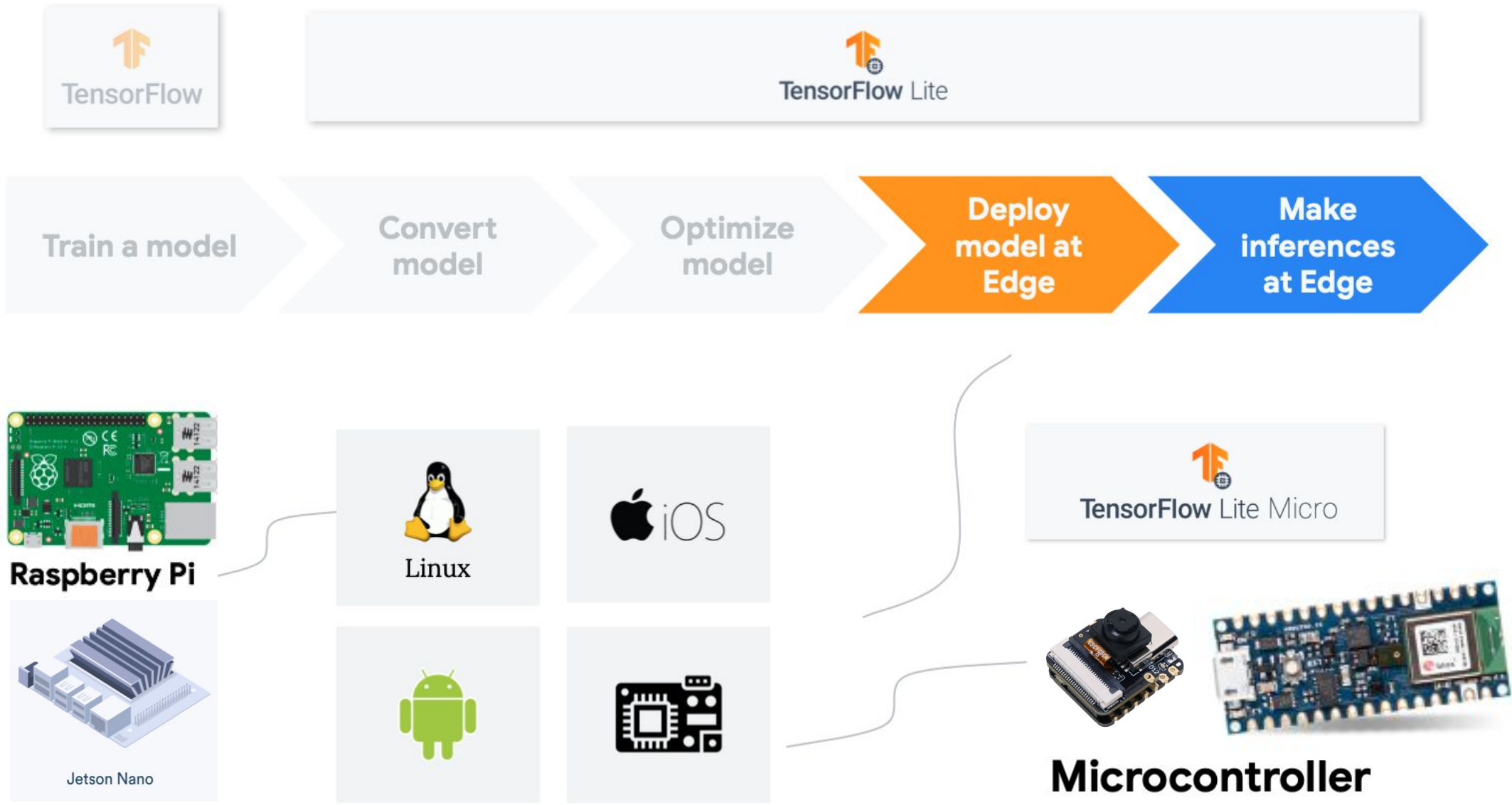


SmartPhone



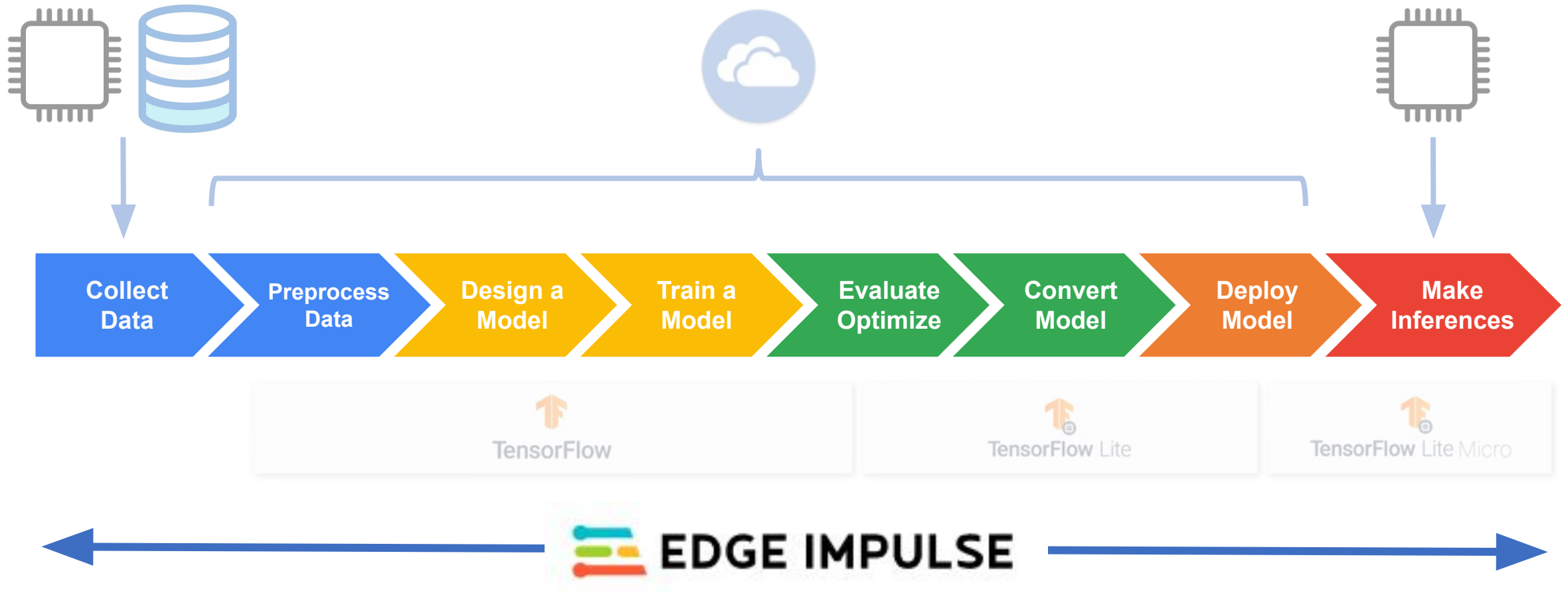
Jetson Nano
(Cortex-A + GPU)

Software

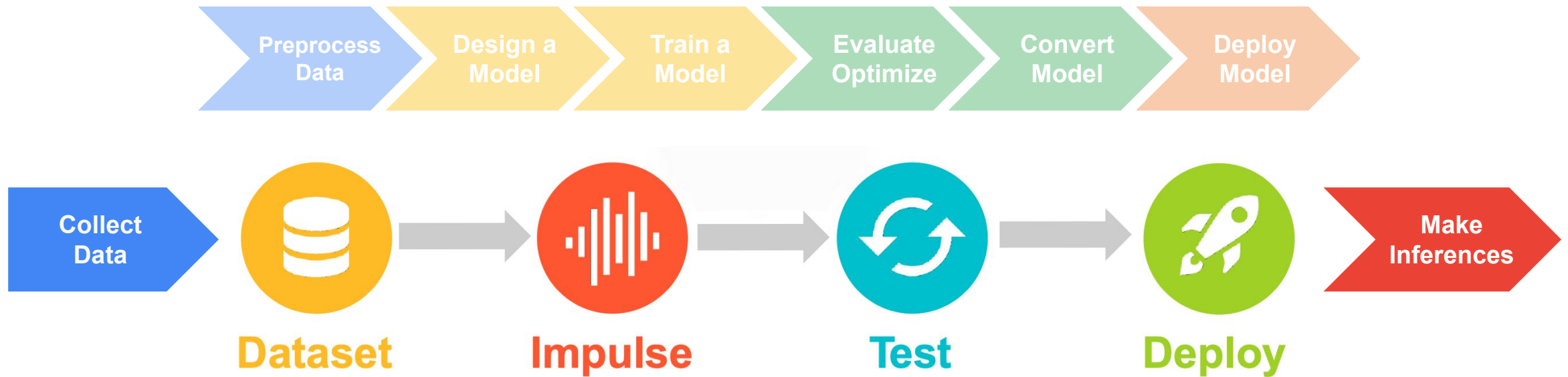


How to Train a ML Model?

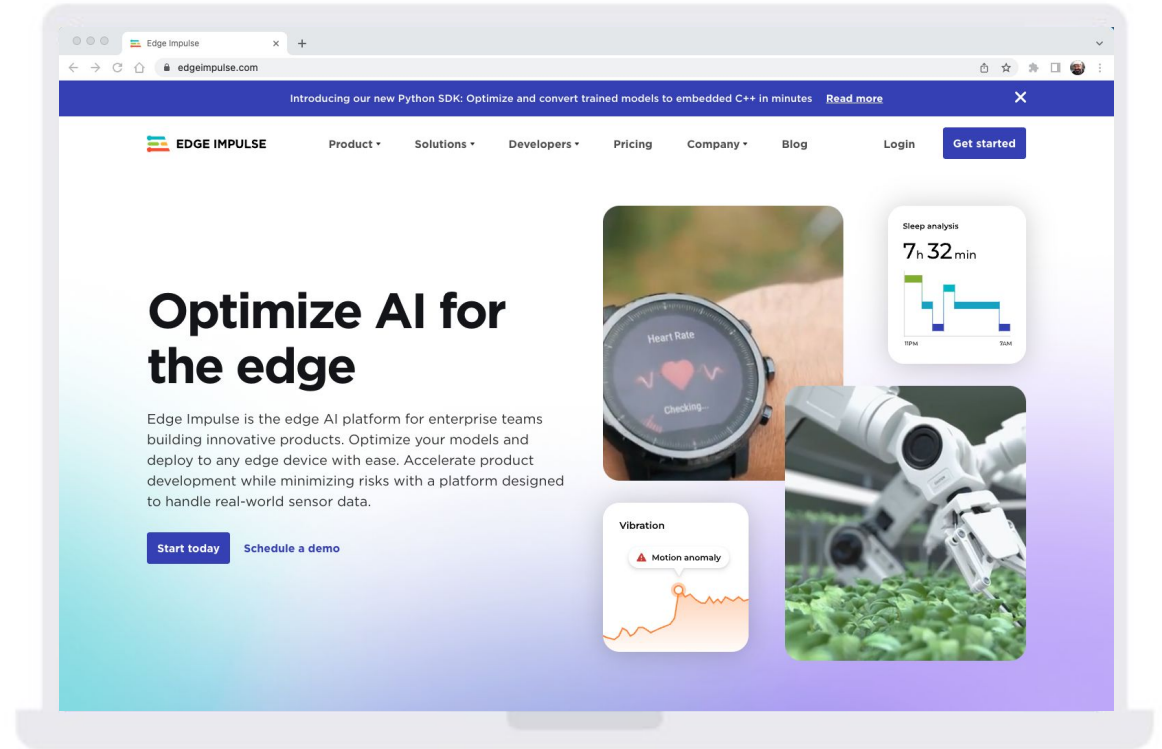
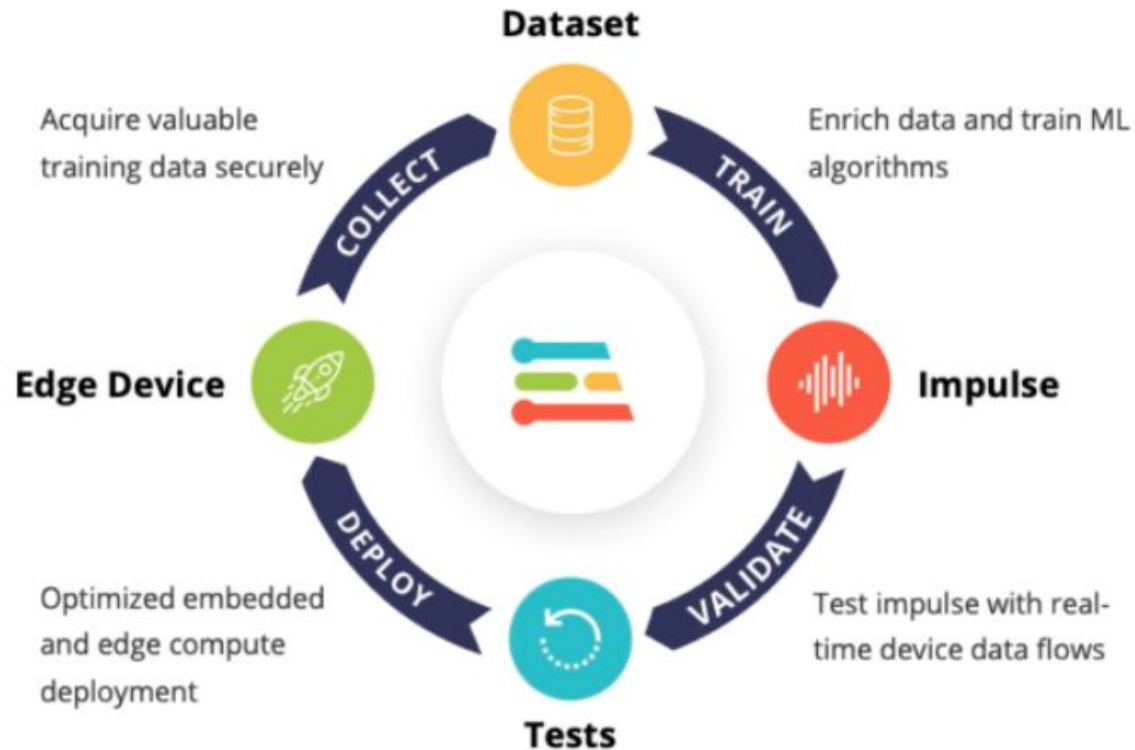
Machine Learning Workflow



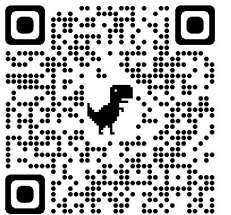
Machine Learning Workflow



EI Studio - Embedded ML platform

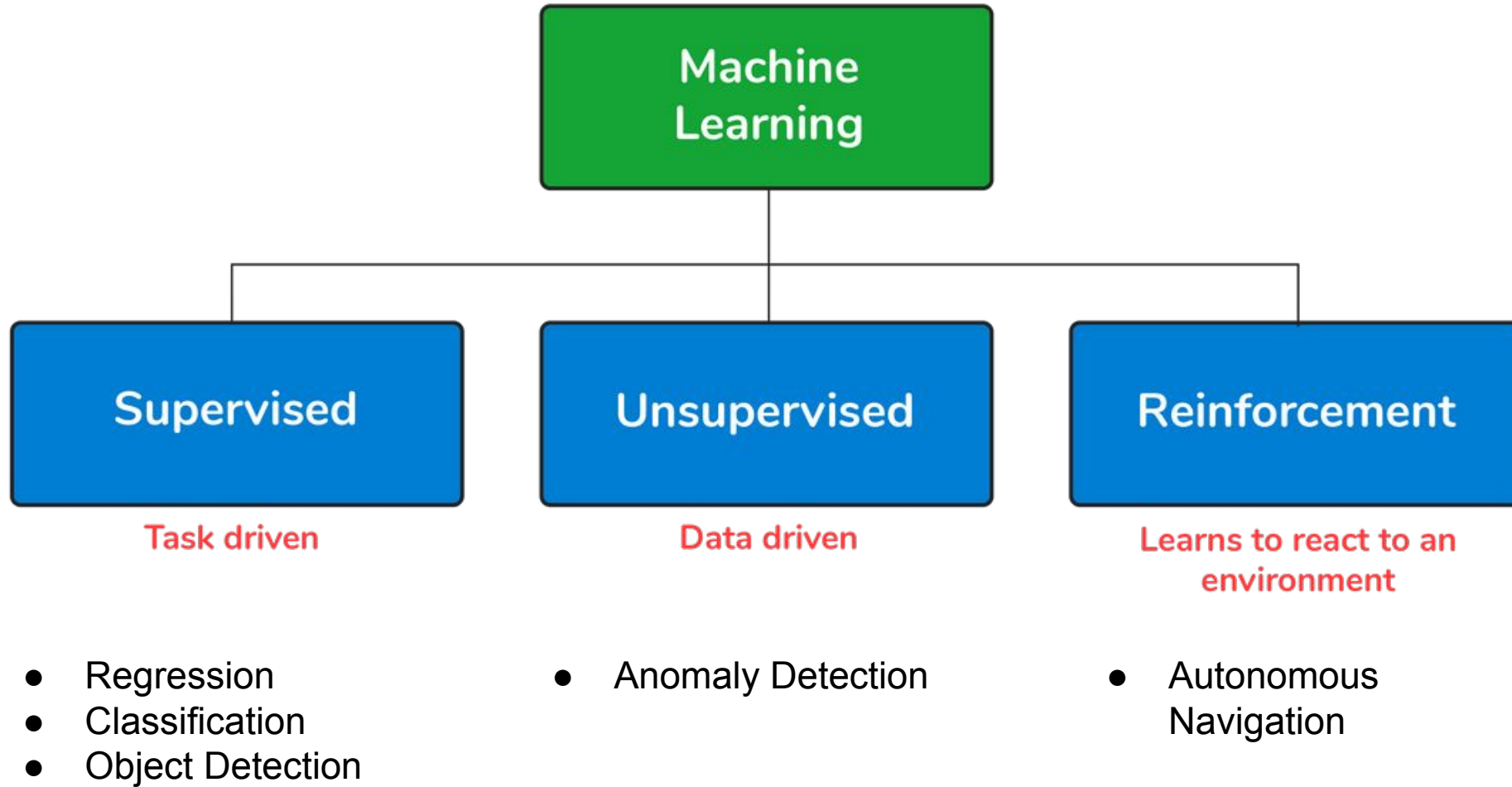


Learn more at <http://edgeimpulse.com>



TinyML Application

Examples



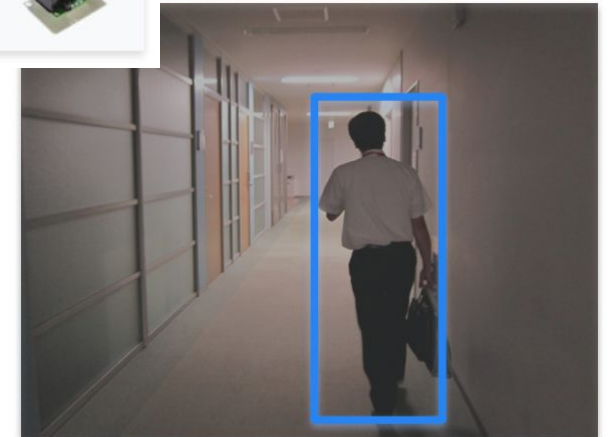
Sound



Vibration



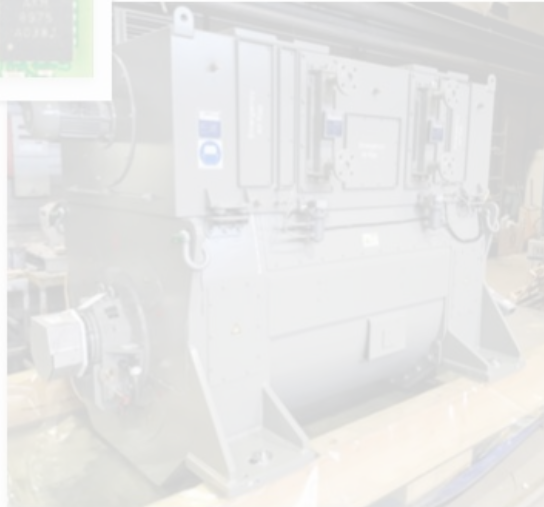
Vision



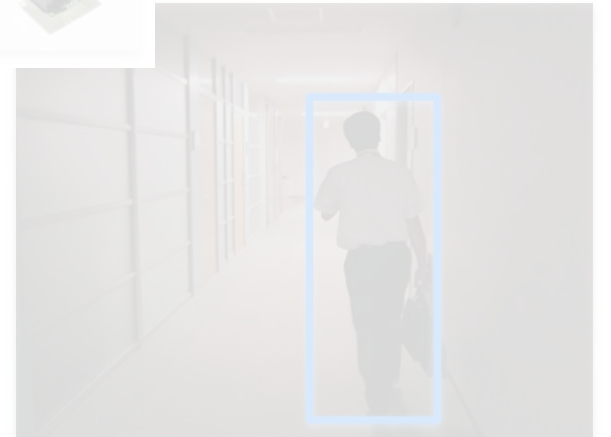
Sound



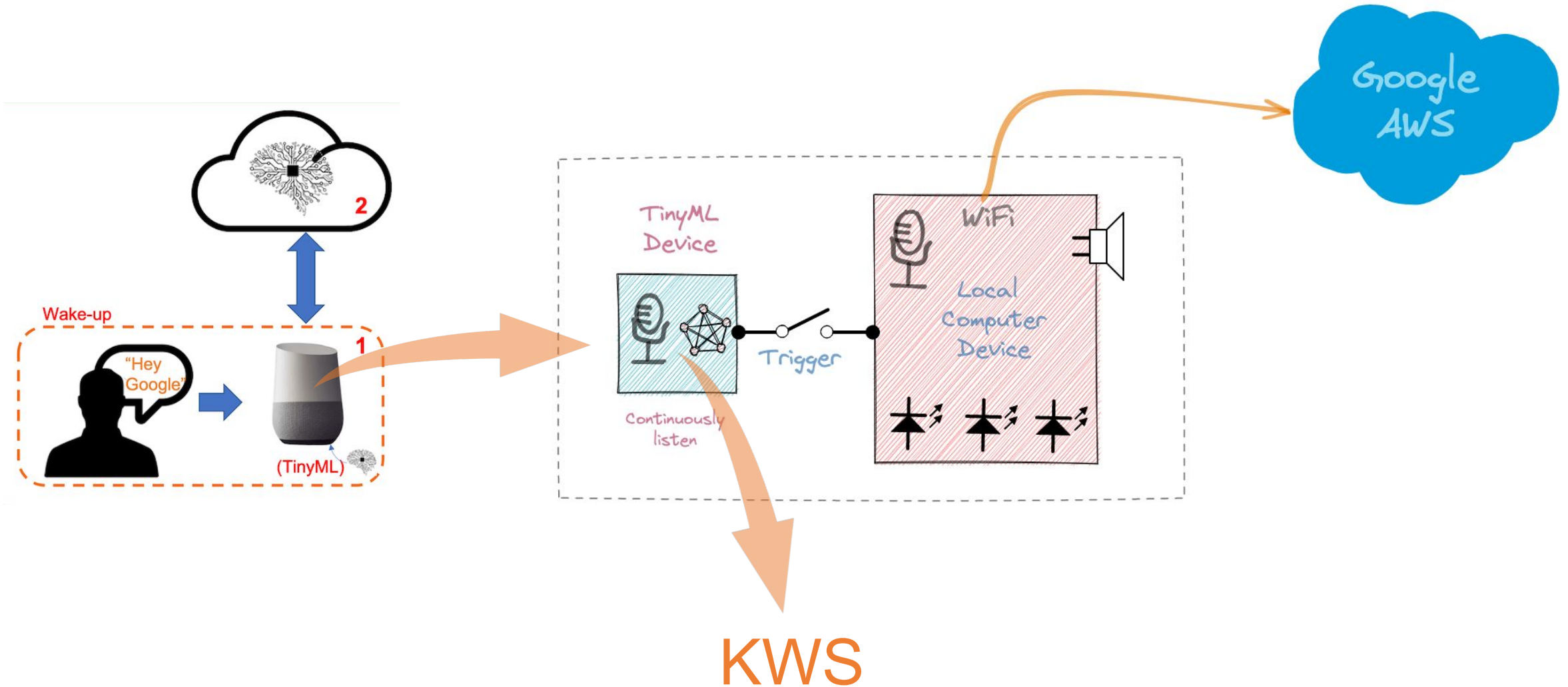
Vibration



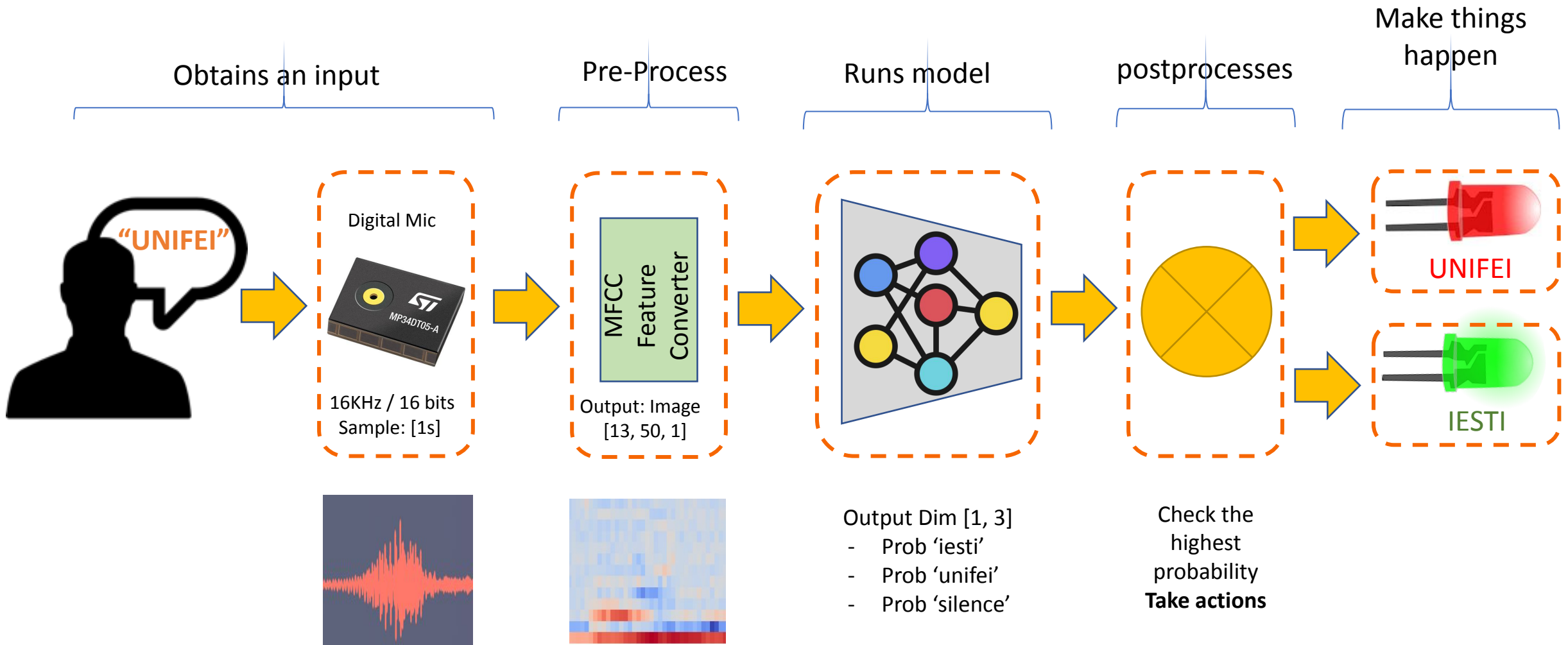
Vision



Personal Assistant



KeyWord Spotting (KWS) - Inference



<https://youtu.be/XnFYz-RSNe8>

Sound



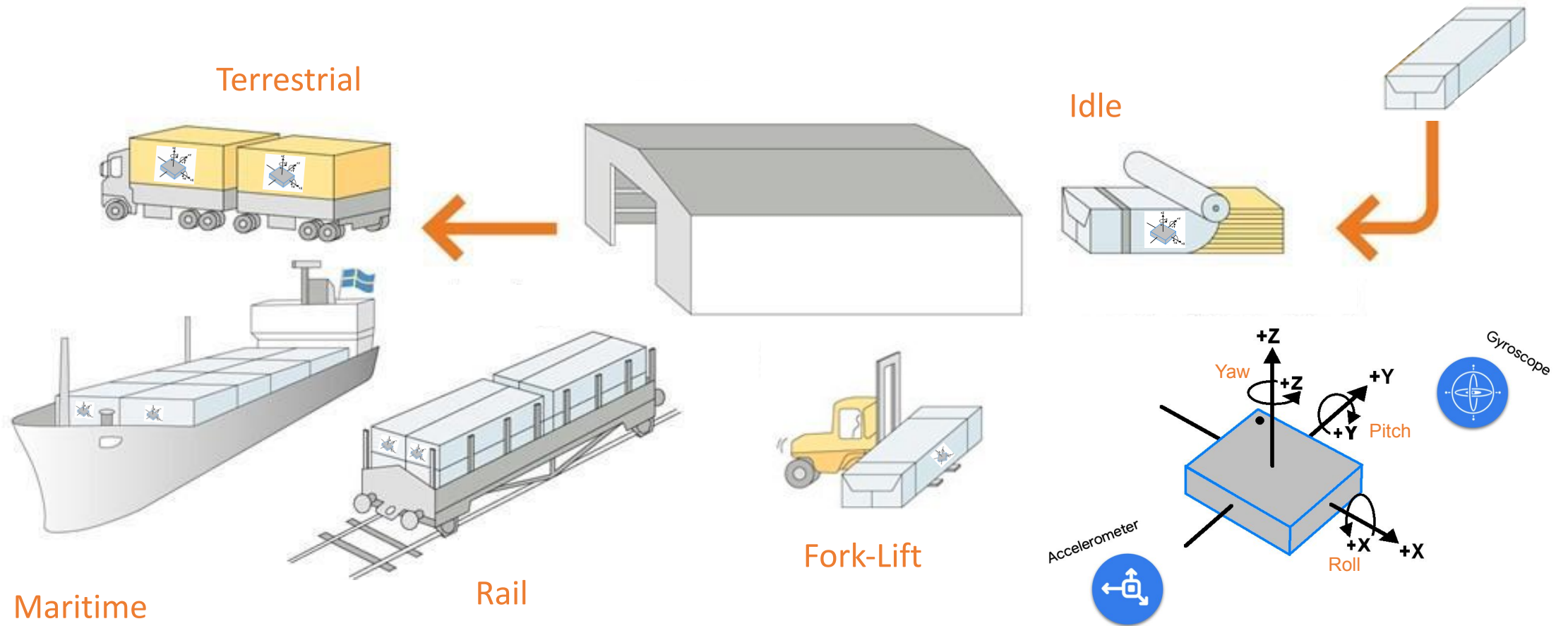
Vibration



Vision



Mechanical Stresses in Transport



Sliding Window: 200 ms

2 second window



300 Raw Features

Manual Feature
Extraction

Raw Data
from sensor

Spectral
Analysis

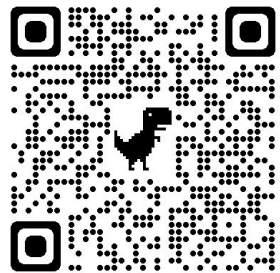
Features

- RMS
- SKEW
- KURT
- FFT
- PSD

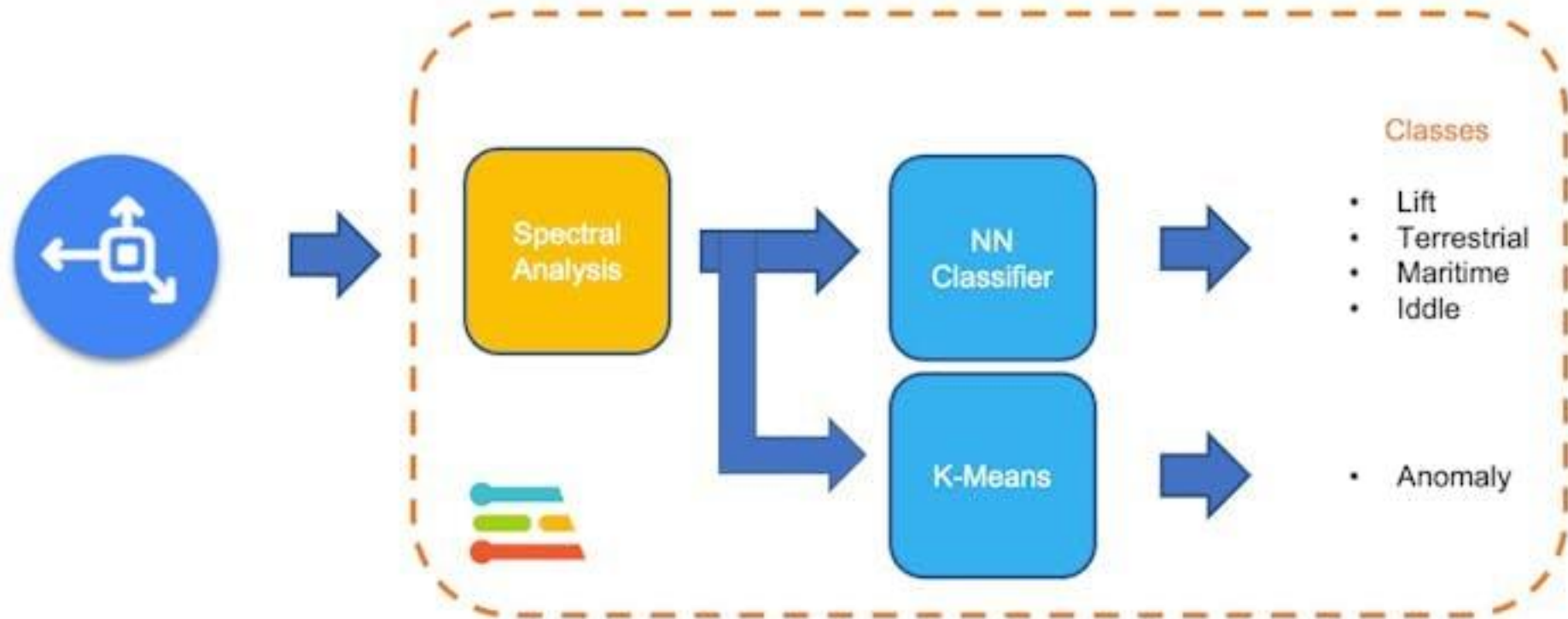
NN
Classifier

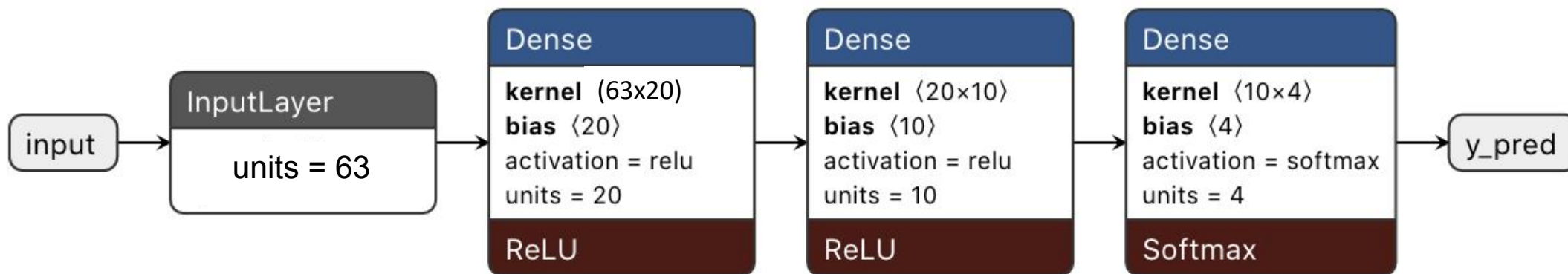
Classes

- Lift
- Terrestrial
- Maritime
- Idle



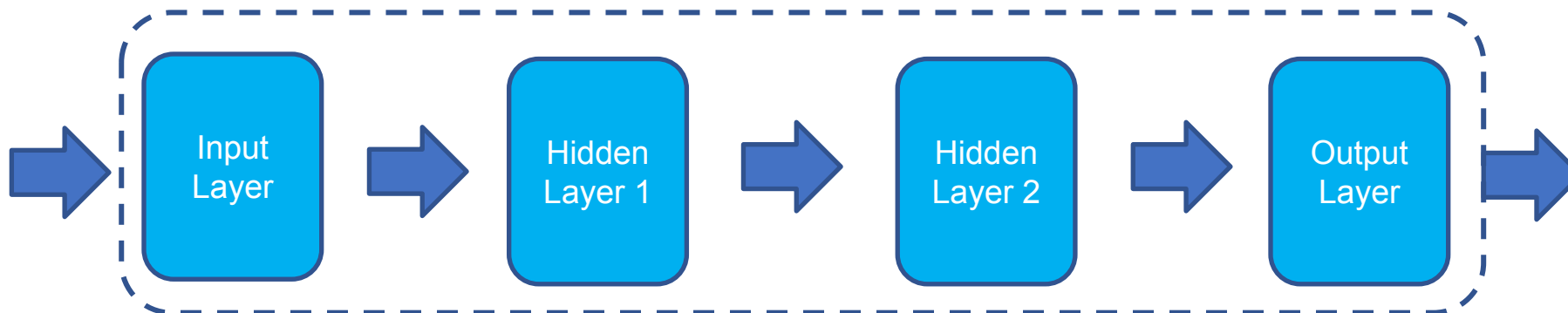
TinyML under the
hood: Spectral
Analysis





63 Features

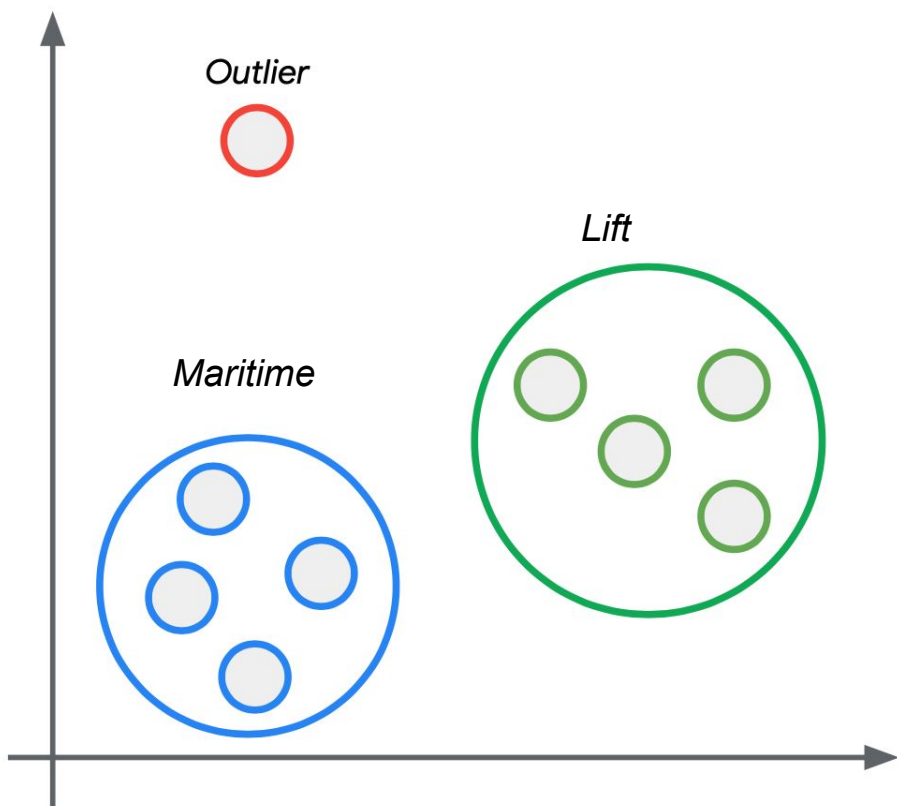
- RMS
- SKEW
- KURT
- FFT
- PSD



Classes

- Lift
- Terrestrial
- Maritime
- Idle

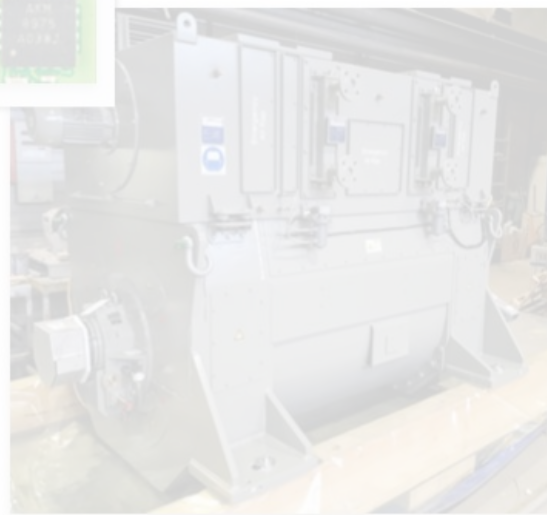
Anomaly Detection – K-Means



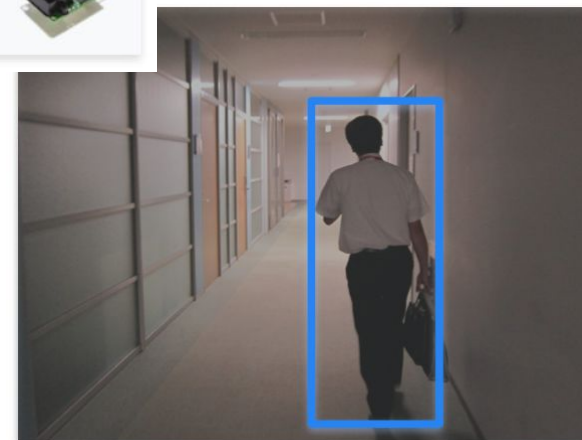
Sound



Vibration



Vision



Computer Vision Main Types

Image Classification (Multi-Class Classification)

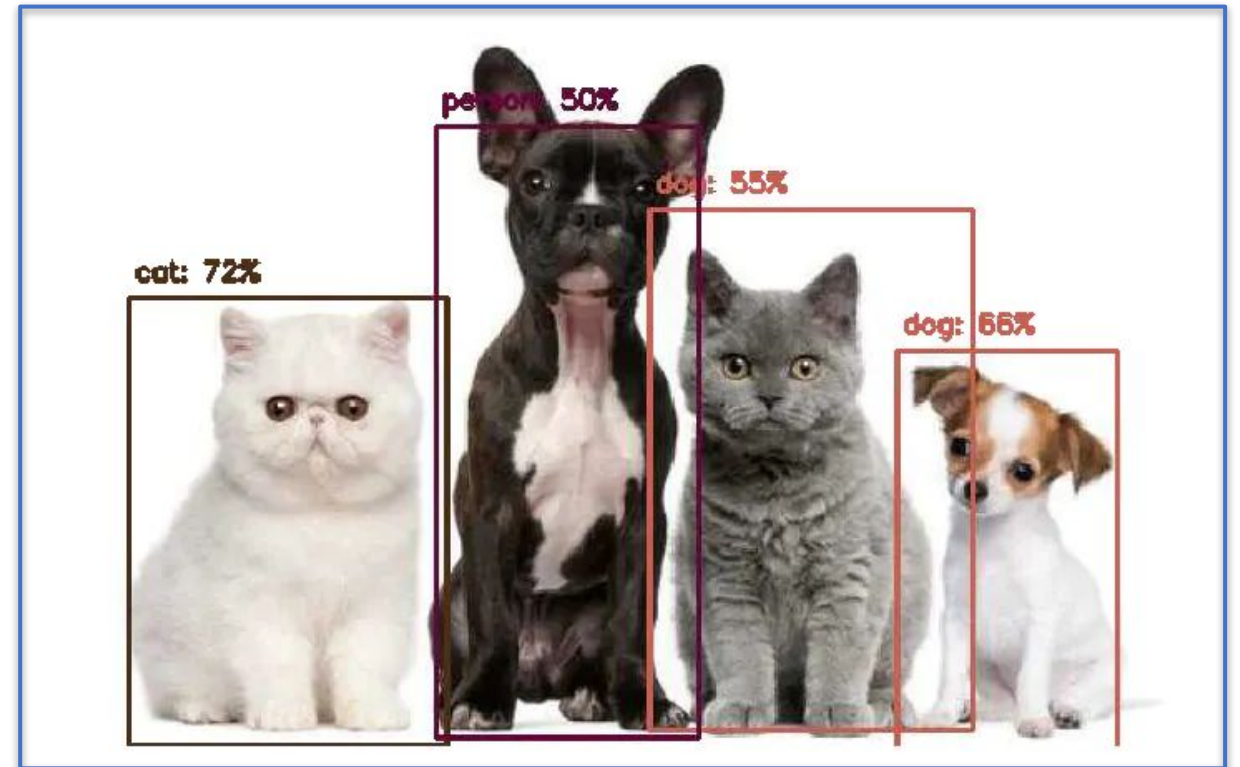


Cat: 70%



Dog: 80%

Object Detection Multi-Label Classification + Object Localization



Computer Vision Main Types

Image Classification (Multi-Class Classification)



Cat: 70%



Dog: 80%

Object Detection Multi-Label Classification + Object Localization

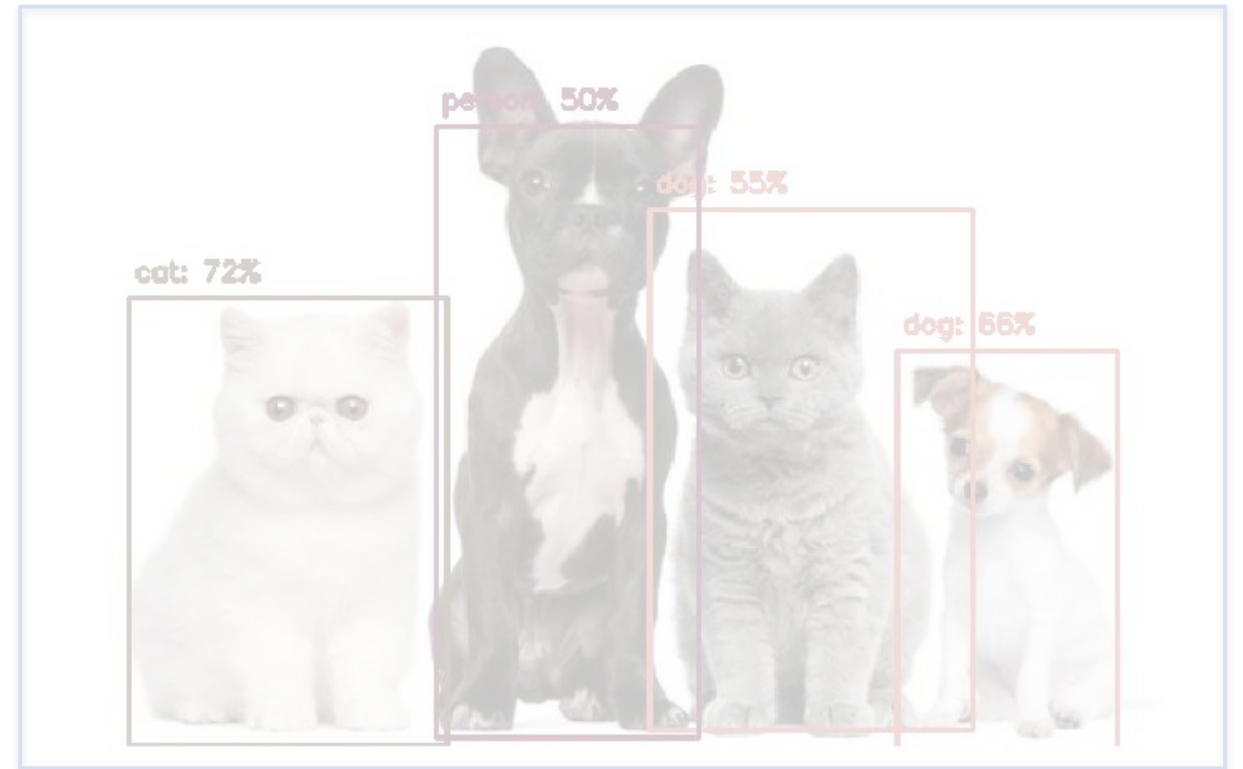
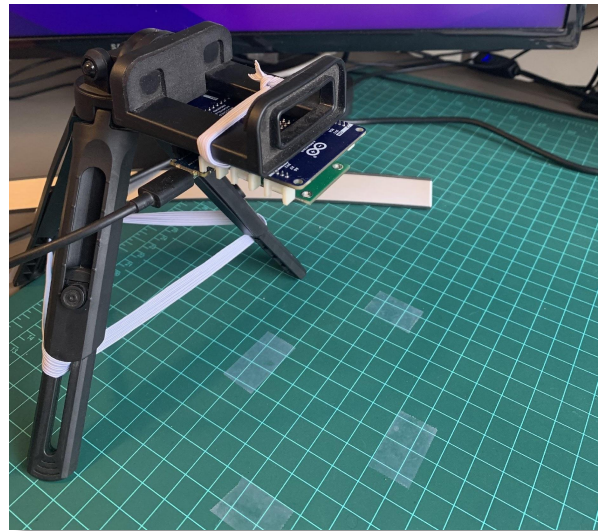
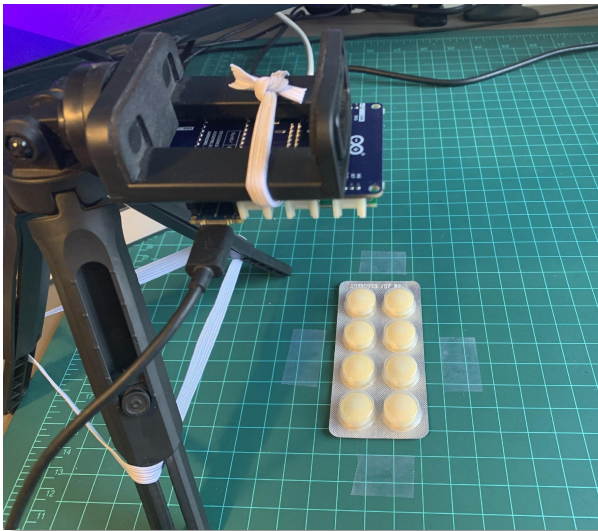
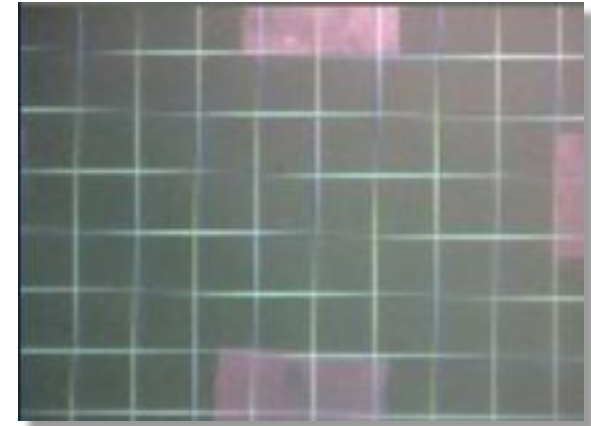


Image Classification Project

Decide a Goal

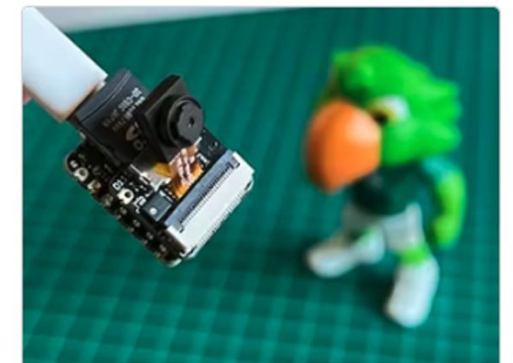
- Possible Images:
 - Medicine
 - background



```

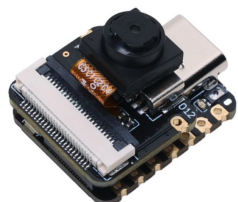
/dev/cu.usbmodem1101
10:44:47.849 -> banana: 0.01953
10:44:47.849 -> potato: 0.12891
10:44:48.103 -> Predictions (DSP: 3 ms., Classification: 135 ms., Anomaly: 0 ms.):
10:44:48.103 -> apple: 0.86328
10:44:48.103 -> banana: 0.03906
10:44:48.103 -> potato: 0.10156
10:44:48.356 -> Predictions (DSP: 3 ms., Classification: 135 ms., Anomaly: 0 ms.):
10:44:48.356 -> apple: 0.90234
10:44:48.356 -> banana: 0.02344
10:44:48.356 -> potato: 0.07422
10:44:48.612 -> Predictions (DSP: 3 ms., Classification: 135 ms., Anomaly: 0 ms.):
10:44:48.612 -> apple: 0.91797
10:44:48.612 -> banana: 0.02344
10:44:48.612 -> potato: 0.05859
10:44:48.861 -> Predictions (DSP: 3 ms., Classification: 135 ms., Anomaly: 0 ms.):
10:44:48.861 -> apple: 0.88281
10:44:48.861 -> banana: 0.03516
10:44:48.861 -> potato: 0.08203
10:44:49.114 -> Predictions (DSP: 3 ms., Classification: 135 ms., Anomaly: 0 ms.):

```



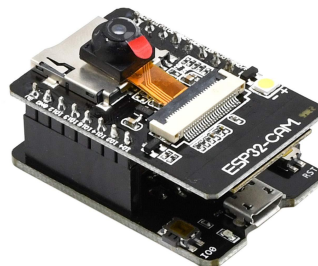
TinyML Made Easy: Image Classification

MJRoBot (Marcelo Rovai)



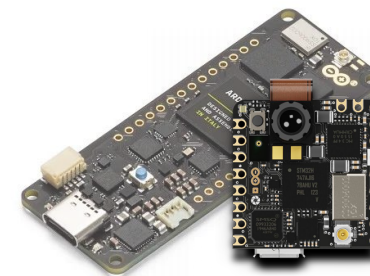
135 ms

XIAO ESP32S3
Xtensa LX7
240 MHz



171 ms

ESP - CAM
Xtensa LX6
240 MHz



45 ms

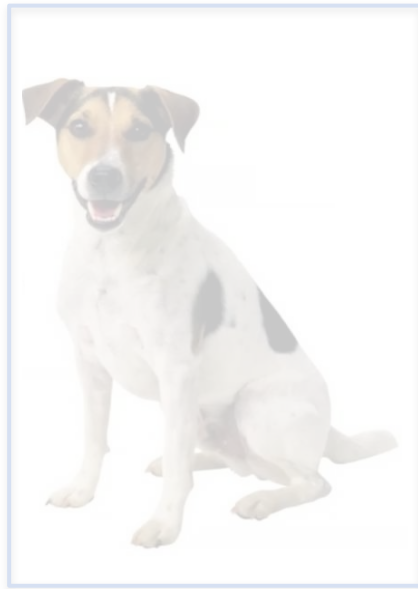
ARDUINO Pro
ARM H7
480 MHz

Computer Vision Main Types

Image Classification (Multi-Class Classification)

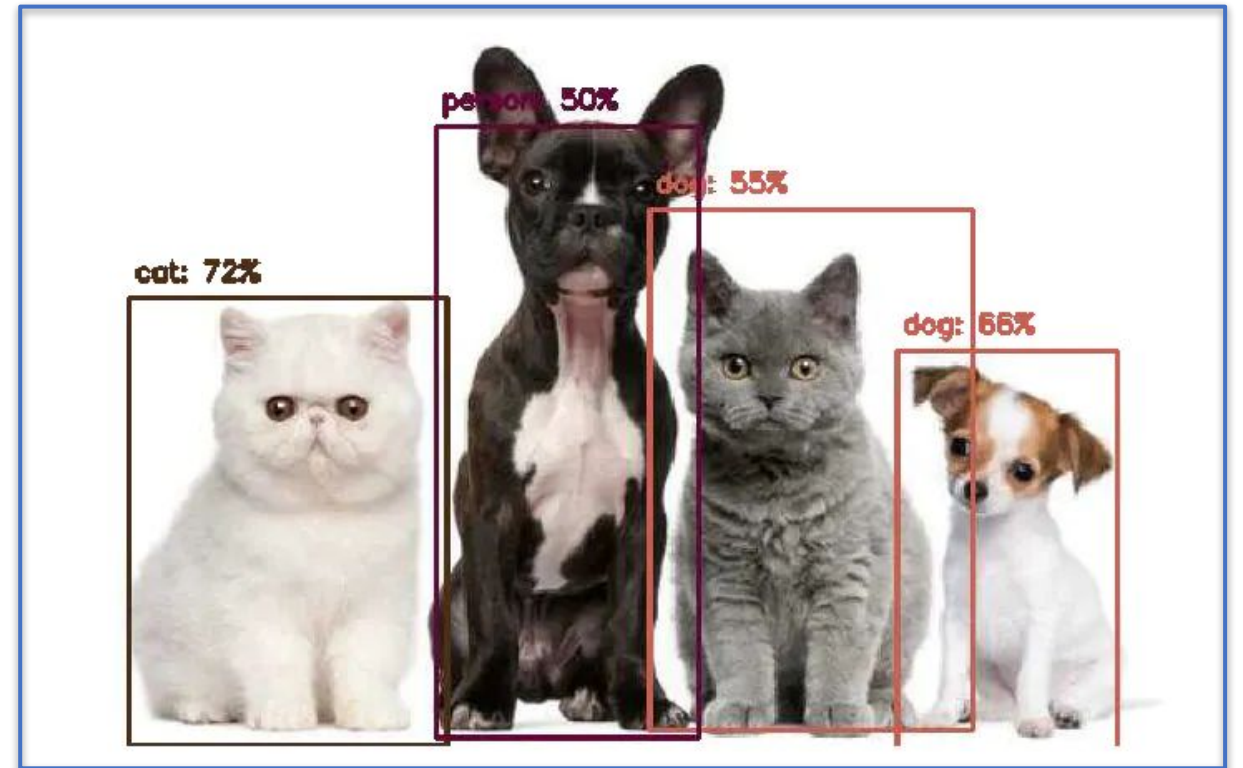


Cat: 70%

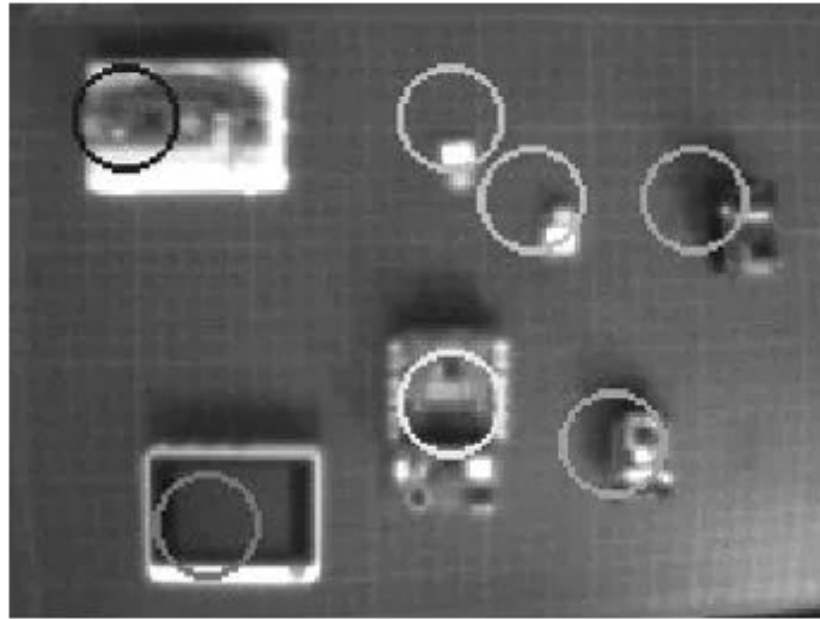


Dog: 80%

Object Detection Multi-Label Classification + Object Localization



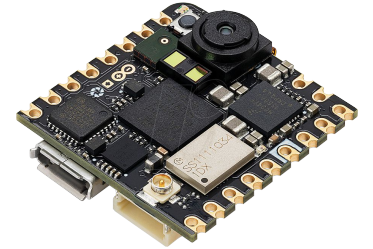
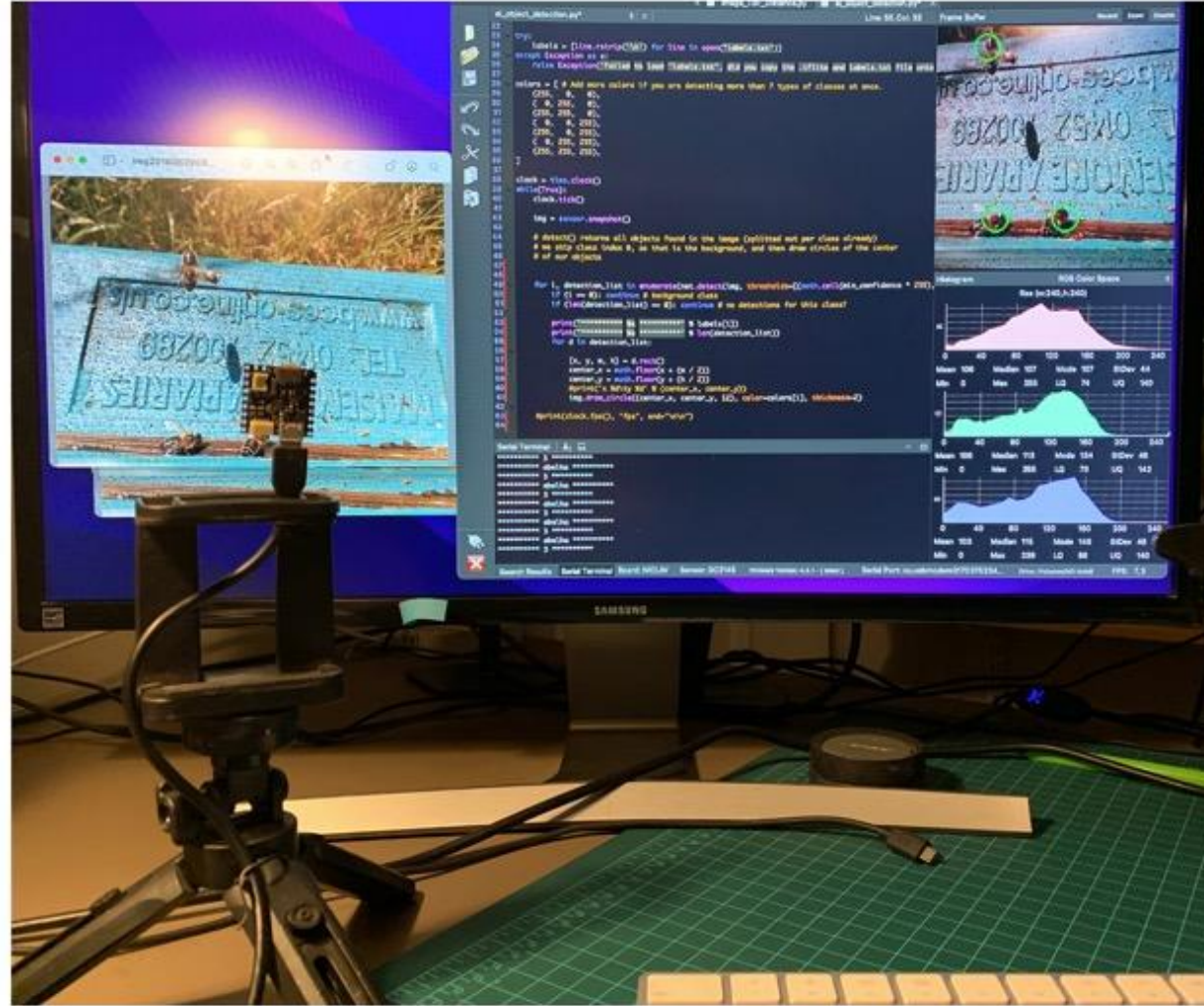
Detecting Objects using TinyML (FOMO)



```
***** espcam *****  
x 70    y 150  
x 130   y 170  
***** nano *****  
x 70    y 110  
***** pico *****  
x 150   y 30  
***** wio *****  
x 50    y 50  
***** xiao *****  
x 150   y 110  
x 130   y 130  
6.97512 fps
```

[EdgeAI made simple - Exploring Image Processing \(Object Detection\) on microcontrollers with Arduino Portenta, Edge Impulse FOMO, and OpenMV](#)

Detecting Objects using TinyML (FOMO)

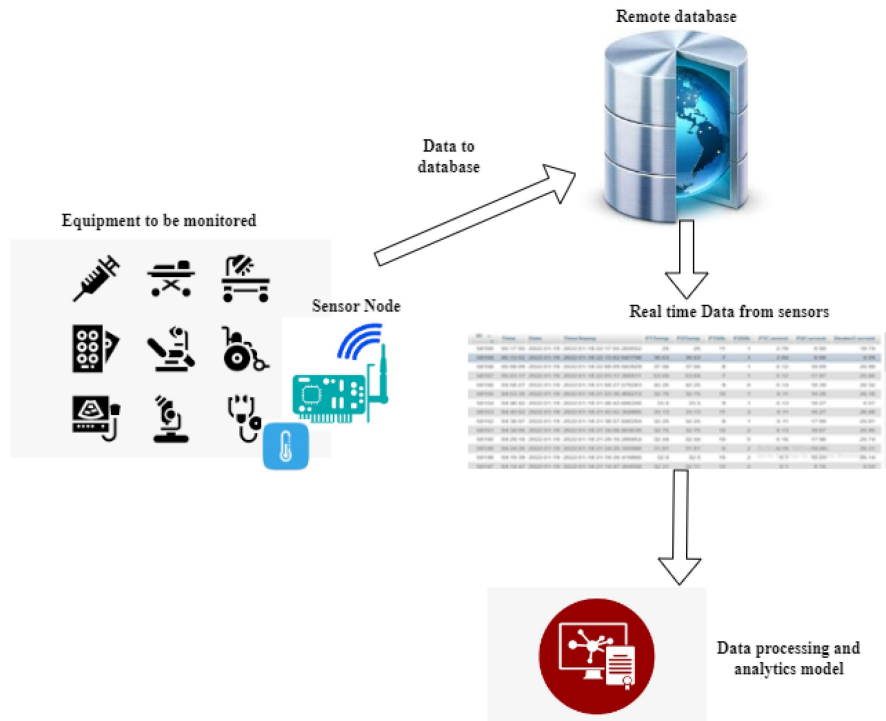
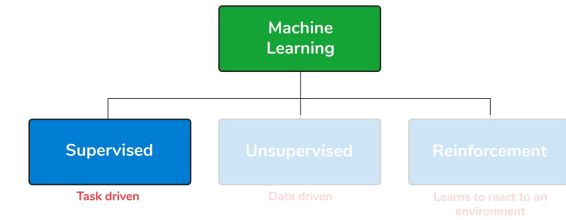


MicroPython



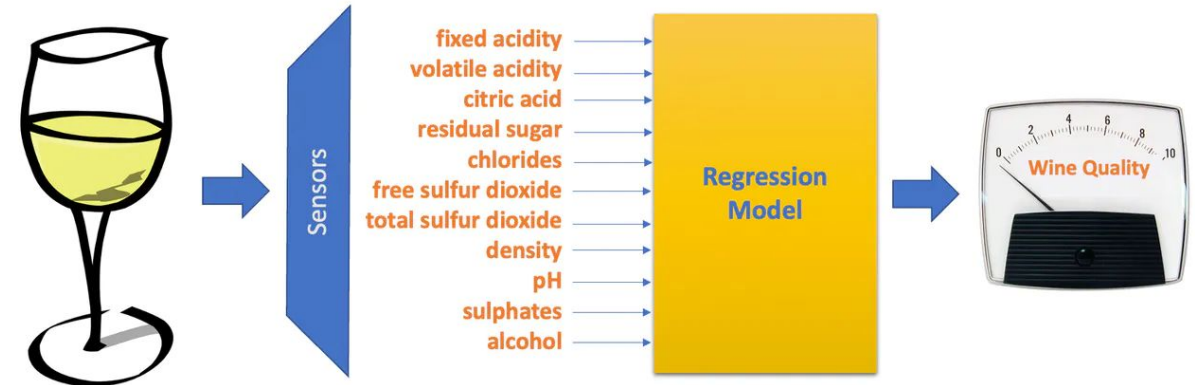
<https://youtu.be/jOZKxO3KnIA>

Regression on TinyML



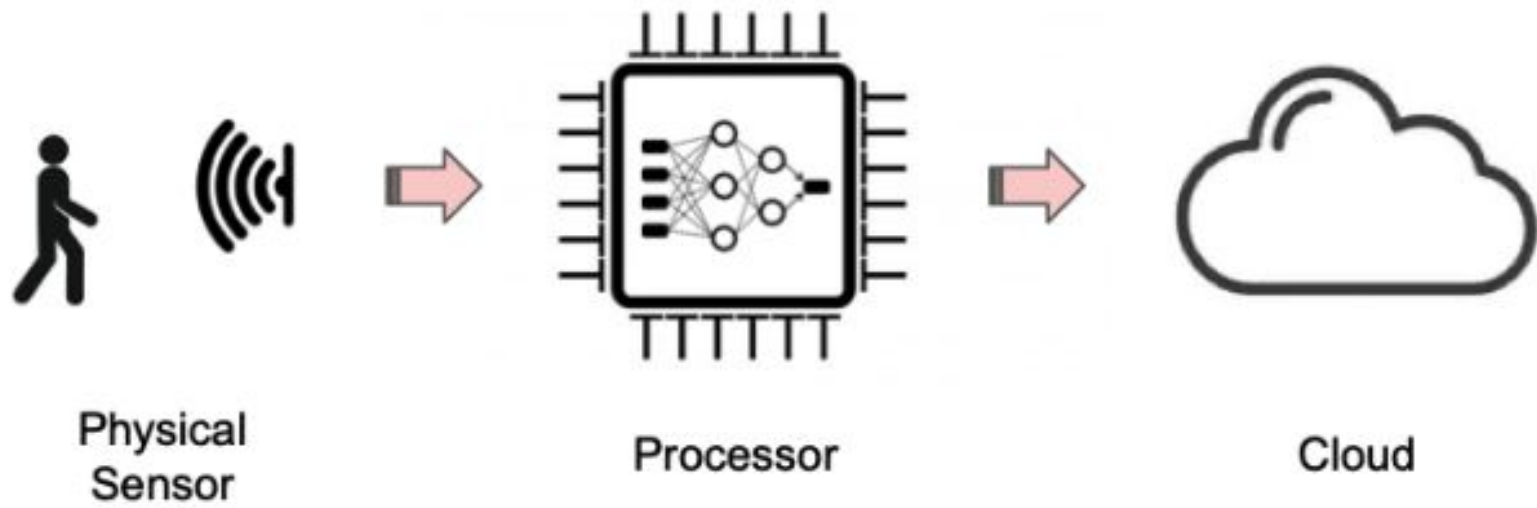
On-Device IoT-Based Predictive Maintenance Analytics Model: Comparing TinyLSTM and TinyModel from Edge Impulse

Sensor fusion

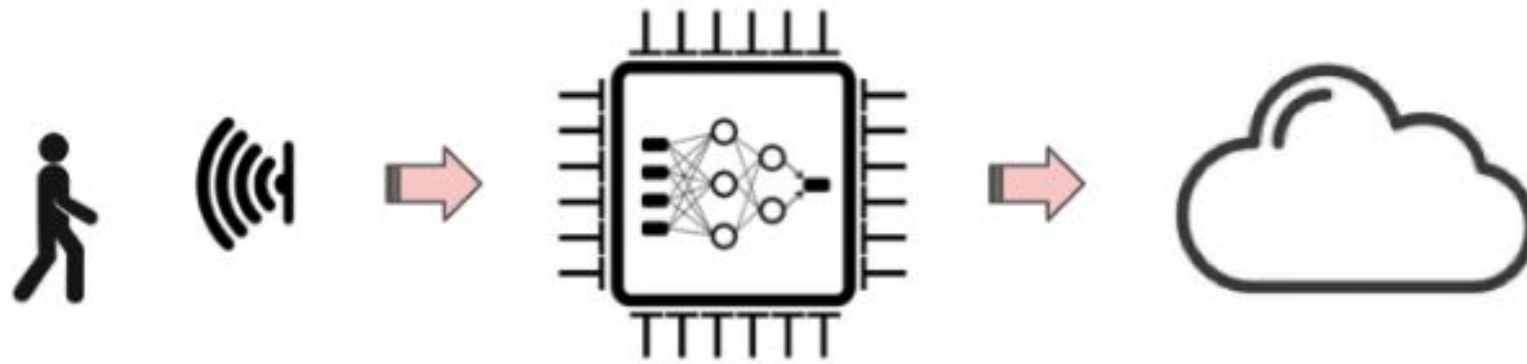


TinyML Made Easy: Exploring Regression - White Wine Quality

The Future of the EdgeAI/ML



Sensor 1.0

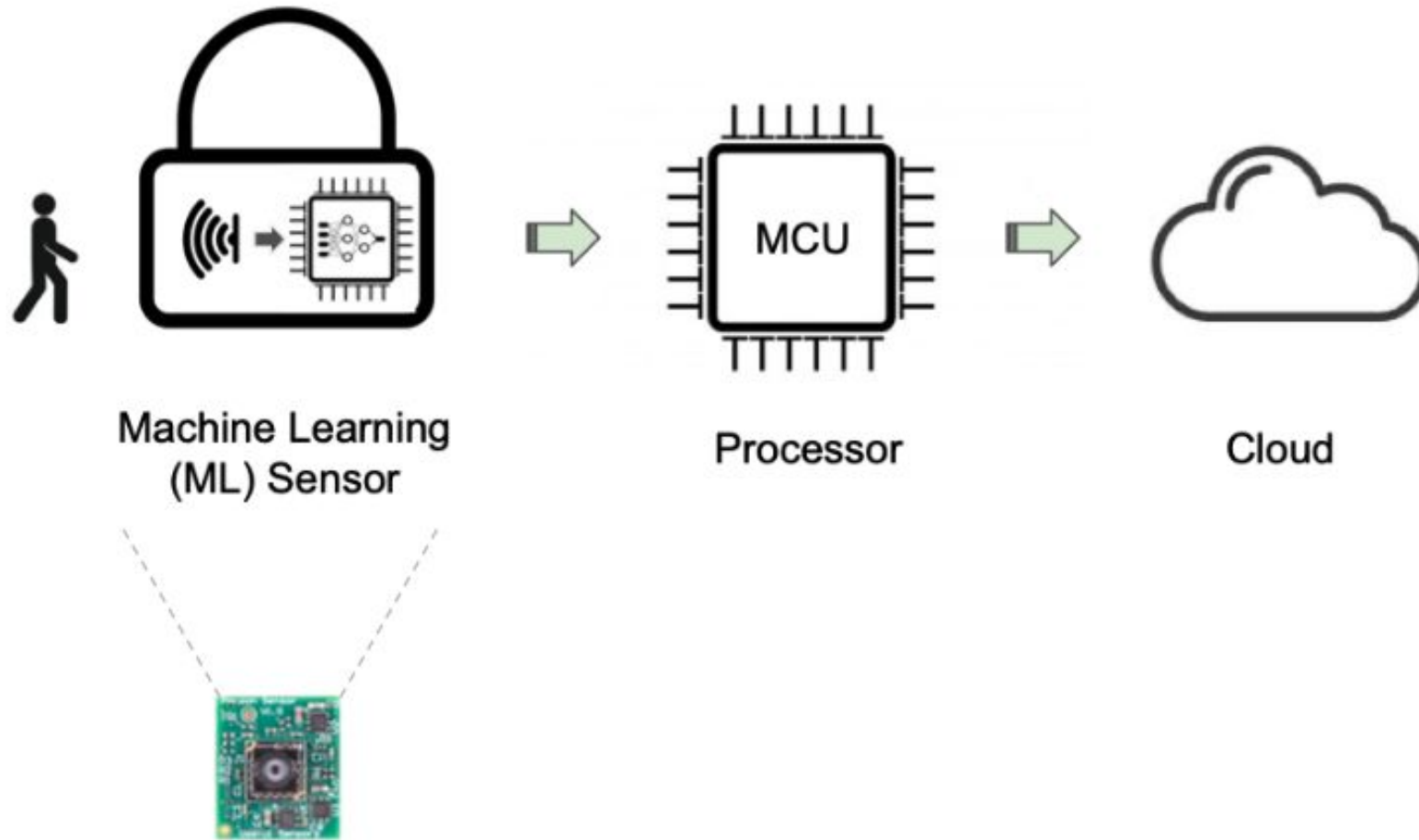


Physical
Sensor

Processor

Cloud





Sensor 2.0



Person
detector



Gaze
sensor



Voice
command



Text
recognizer



...



The Person Sensor has built in facial recognition and determines how many people there are, as well as their relative position.

Bosch BME688 - Environmental sensing with AI



Relative humidity barometric pressure



Excellent temperature stability



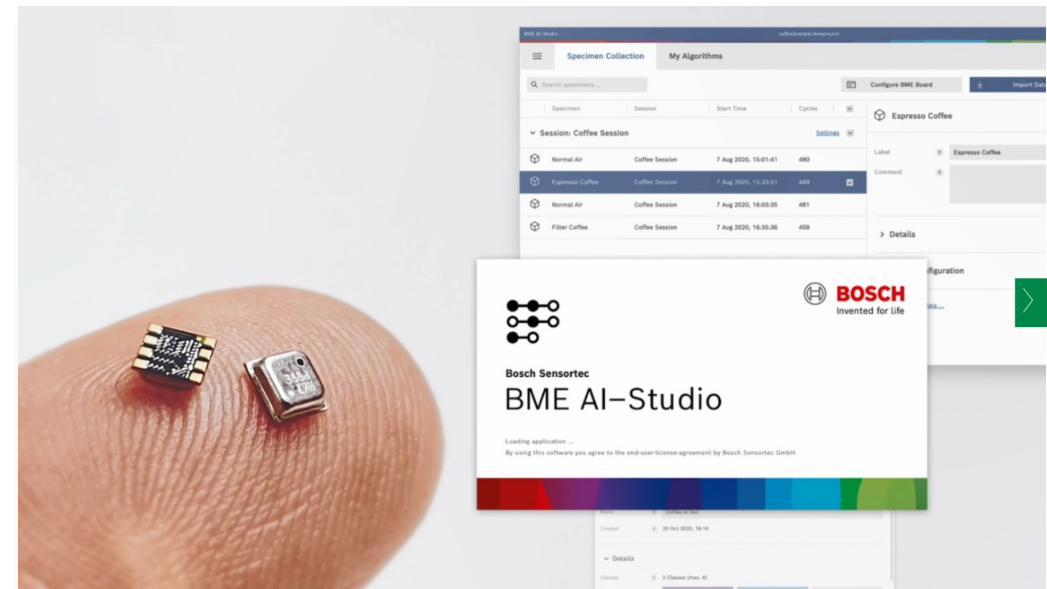
Humidity



Gas sensing



<https://www.bosch-sensortec.com/products/environmental-sensors/gas-sensors/bme688/>



mlsensors.org

<https://github.com/harvard-edge/ML-Sensors>

arXiv:2206.03266v1 [cs.LG] 7 Jun 2022

MACHINE LEARNING SENSORS

Pete Warden¹ Matthew Stewart² Brian Plancher² Colby Banbury² Shvetank Prakash² Emma Chen²
Zain Asgar¹ Sachin Katti¹ Vijay Janapa Reddi²

¹Stanford University ²Harvard University

ABSTRACT

Machine learning sensors represent a paradigm shift for the future of embedded machine learning applications. Current instantiations of embedded machine learning (ML) suffer from complex integration, lack of modularity, and privacy and security concerns from data movement. This article proposes a more data-centric paradigm for embedding sensor intelligence on edge devices to combat these challenges. Our vision for “sensor 2.0” entails segregating sensor input data and ML processing from the wider system at the hardware level and providing a thin interface that mimics traditional sensors in functionality. This separation leads to a modular and easy-to-use ML sensor device. We discuss challenges presented by the standard approach of building ML processing into the software stack of the controlling microprocessor on an embedded system and how the modularity of ML sensors alleviates these problems. ML sensors increase privacy and accuracy while making it easier for system builders to integrate ML into their products as a simple component. We provide examples of prospective ML sensors and an illustrative datasheet as a demonstration and hope that this will build a dialogue to progress us towards sensor 2.0.

1 INTRODUCTION

Since the advent of AlexNet [43], deep neural networks have proven to be robust solutions to many challenges that involve making sense of data from the physical world. Machine learning (ML) models can now run on low-cost, low-power hardware capable of deployment as part of an embedded device. Processing data close to the sensor on an embedded device allows for an expansive new variety of always-on ML use-cases that preserve bandwidth, latency, and energy while improving responsiveness and maintaining data privacy. This emerging field, commonly referred to as embedded ML or tiny machine learning (TinyML) [73, 18, 39, 59], is paving the way for a prosperous new array of use-cases, from personalized health initiatives to improving manufacturing productivity and everything in-between.

However, the current practice for combining inference and sensing is cumbersome and raises the barrier of entry to embedded ML. At present, the general design practice is to design or leverage a board with decoupled sensors and compute (in the form of a microcontroller or DSP), and for the developer to figure out how to run ML on these embedded platforms. The developer is expected to train and optimize ML models and fit them within the resource constraints of the embedded device. Once an acceptable prototype implementation is developed, the model is integrated with the rest of the software on the device. Finally, the widget is tethered to the device under test to run inference. The current approach is slow, manual, energy-inefficient, and error-prone.

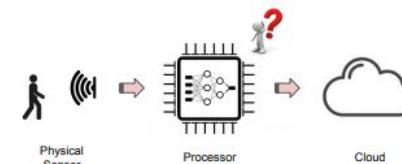


Figure 1. The Sensor 1.0 paradigm tightly couples the ML model with the application processor and logic, making it difficult to provide hard guarantees about the ML sensor’s ultimate behavior.

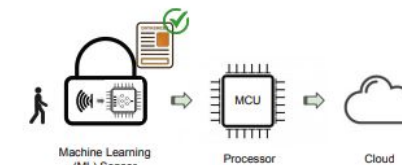
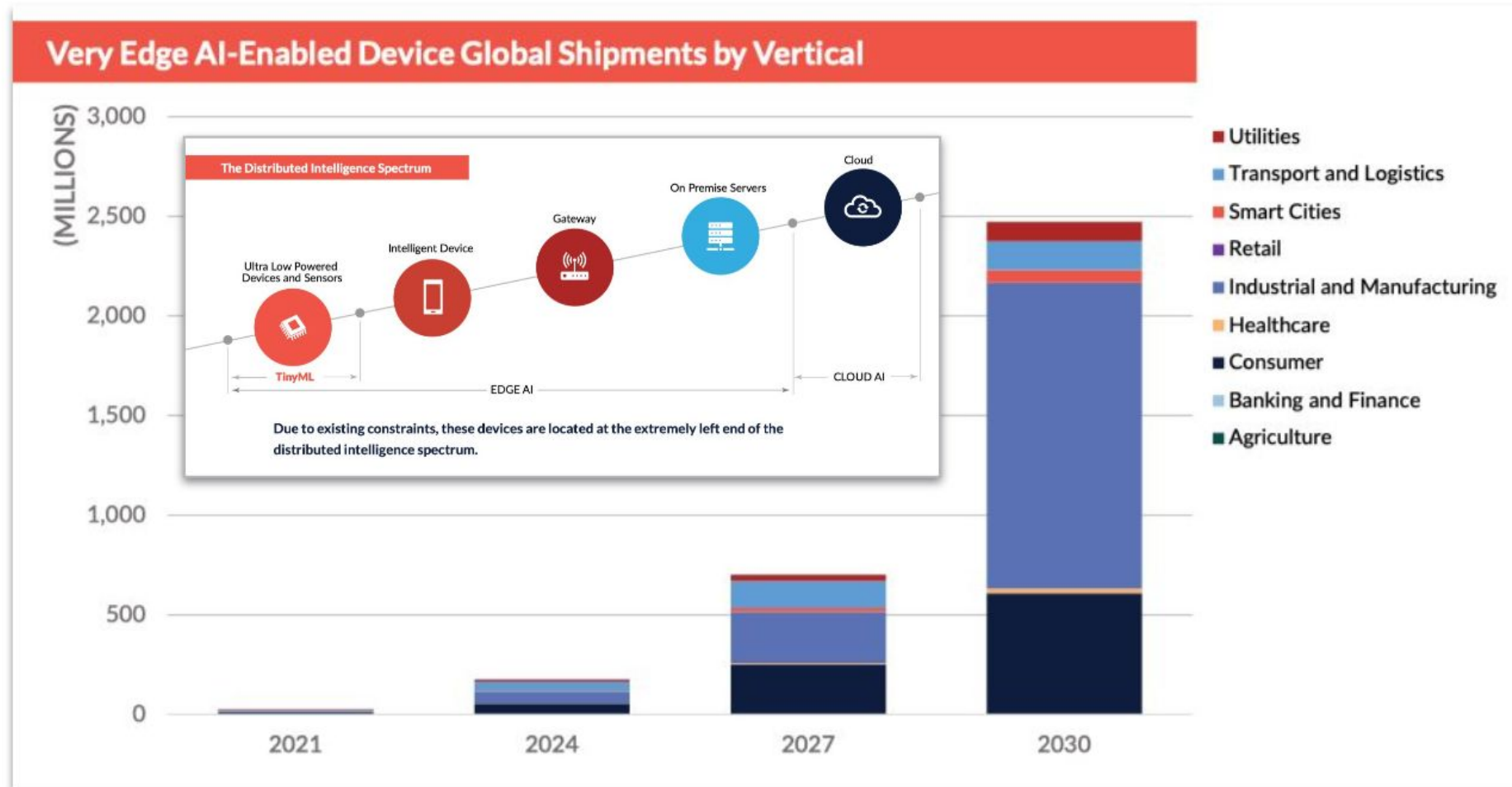


Figure 2. Our proposed Sensor 2.0 paradigm. The ML model is tightly coupled with the physical sensor, separate from the application processor, and comes with an ML sensor datasheet that makes its behavior transparent to the system integrators and developers.

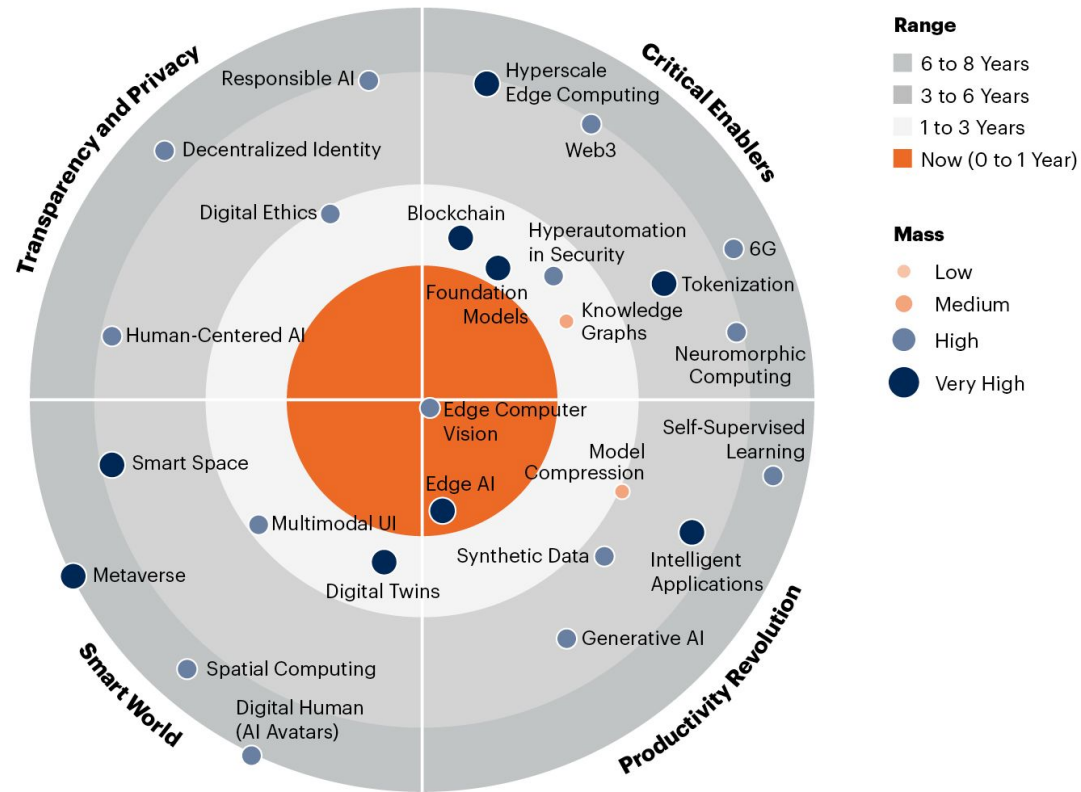
It requires a sophisticated understanding of ML and the intricacies of ML model implementations to optimize and fit a model within the constraints of the embedded device.

Massive Potential for Impact



Source: ABI Research: TinyML

2023 Gartner Emerging Technologies and Trends Impact Radar



gartner.com

Note: Range measures number of years it will take the technology/trend to cross over from early adopter to early majority adoption. Mass indicates how substantial the impact of the technology or trend will be on existing products and markets.

Source: Gartner
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Gartner

Edge AI has a very high impact potential, and it is for now!

Conclusion



The Future of ML is Tiny and Bright

*Vijay Janapa Reddi, Ph. D. | Associate Professor |
John A. Paulson School of Engineering and Applied Sciences | Harvard University |*



Responsible AI

Suzan Kennedy, Ph.D.



[SciTinyML Seminar - Slides](#)



[SciTinyML Seminar - Video](#)



To learn more ...

- IESTI01 TinyML - Machine Learning for Embedding Devices (Videos: Pt)
- WALC 22 – Applied AI - TinyML (Videos in Spanish)
- Professional Certificate in Tiny Machine Learning (TinyML) – edX/Harvard
- Introduction to Embedded Machine Learning - Coursera/Edge Impulse
- Computer Vision with Embedded Machine Learning - Coursera/Edge Impulse
- "Deep Learning with Python" book by François Chollet
- "TinyML" book by Pete Warden, Daniel Situnayake
- "TinyML Cookbook" by Gian Marco Iodice
- "AI at the Edge" book by Daniel Situnayake, Jenny Plunkett

On the [TinyML4D website](#), You can find lots of educational materials on TinyML. They are all free and open-source for educational uses – we ask that if you use the material, please cite them! TinyML4D is an initiative to make TinyML education available to everyone globally.

Thanks



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